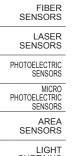
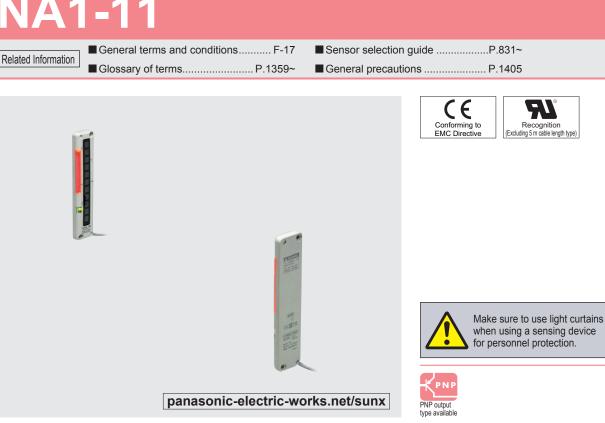
# Small / Slim Object Detection Area Sensor



CURTAINS
PRESSURE / FLOW SENSORS
INDUCTIVE PROXIMITY SENSORS
PARTICULAR

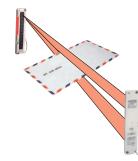
SENSOR OPTIONS
SIMPLE WIRE-SAVING UNITS
WIRE-SAVING SYSTEMS
MEASUREMENT SENSORS
STATIC CONTROL DEVICES
ENDOSCOPE
LASER MARKERS
PLC / TERMINALS
HUMAN MACHINE INTERFACES
ENERGY CONSUMPTION VISUALIZATION COMPONENTS
FA COMPONENTS
MACHINE VISION
SYSTEMS
SYSTEMS UV CURING SYSTEMS



# Cross-beam scanning system to detect slim objects

#### Letters or business cards detectable!

Slim objects can be detected by the cross-beam scanning system.



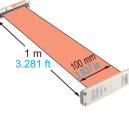
#### Emitting and receiving element pitch: 10 mm 0.394 in

A minimum sensing object size of  $\emptyset$ 13.5 mm  $\emptyset$  0.531 in can be detected by an emitting and receiving element pitch of 10 mm 0.394 in.





slim, it has a wide sensing area of 1 m 3.281 ft length and 100 mm 3.937 in width. It is most suitable for object detection on a wide assembly line, or for detecting the dropping of, or incursion by, small objects whose travel path is uncertain.



#### Just 10 mm 0.394 in thick

It is extremely slim, being just 10 mm 0.394 in thick. Further, it can be mounted in a narrow space as you can select from two cable orientation directions.



It is possible to select from two cable orientation directions.

#### **Globally usable**

It conforms to the EMC Directive and the UL Recognition. Moreover, PNP output type, which is much in demand in Europe, is also available.

Detection Other Products

Selection Guide

Wafer Detection

Liquid Leak Detection

Liquid Level Detection

Color Mark

Detection Hot Melt Glue

Detection

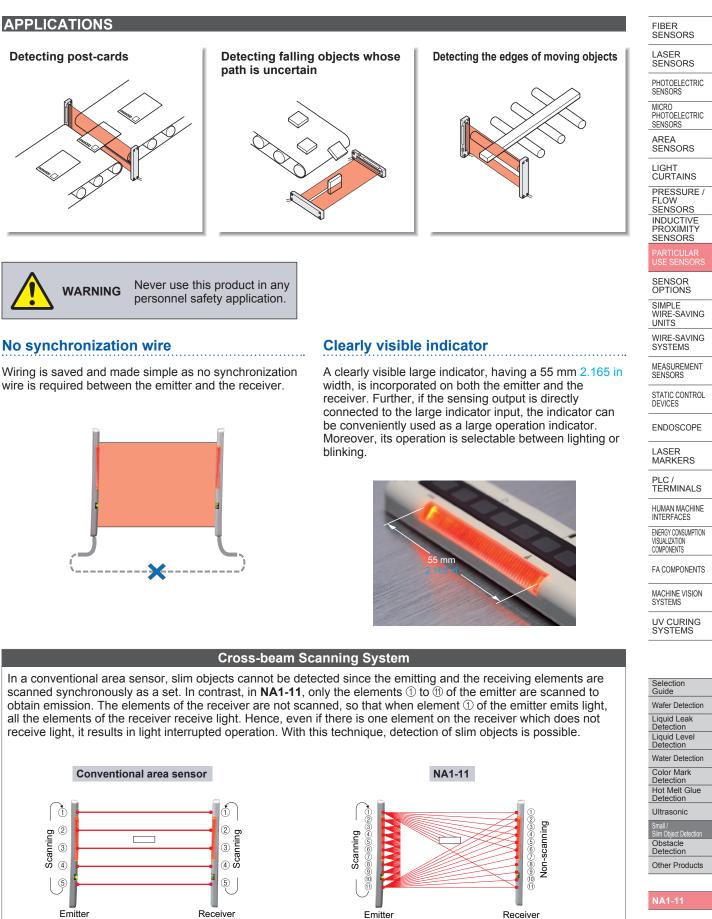
Ultrasonic

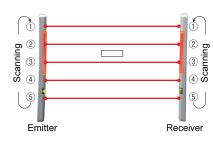
Small / t Detection

Obstacle

Water Detection

# 892





# **ORDER GUIDE**

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SENSOR OPTIONS

SIMPLE WIRE-SAVING UNITS

WIRE-SAVING SYSTEMS

MEASURE-MENT SENSORS

STATIC CONTROL DEVICES

ENDOSCOPE

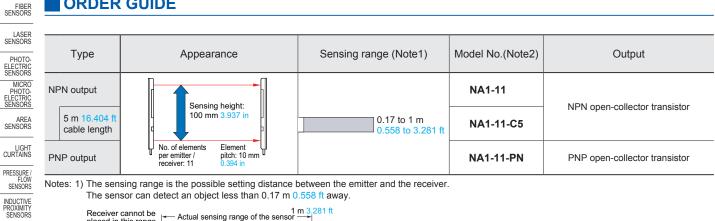
LASER MARKERS

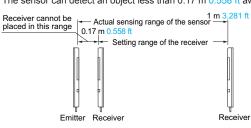
PLC / TERMINALS

HUMAN MACHINE INTERFACES ENERGY CONSUMPTION VISUALIZATION COMPONENTS

COMPONENTS

MACHINE VISION SYSTEMS





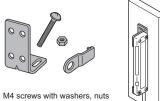
2) The model No. with suffix "P" shown on the label affixed to the product is the emitter, "D" shown on the label is the receiver. (e.g.) Emitter of NA1-11: NA1-11P, Receiver of NA1-11: NA1-11D

# **OPTIONS**

Designation	Model No.	Description
Sensor mounting bracket	MS-NA1-1	Four bracket set Four M4 (length 15 mm 0.591 in) screws with washers,
	MS-NA2-1	eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached. (Spacers are not attached with <b>MS-NA1-1</b> .)

#### or mounting bracket

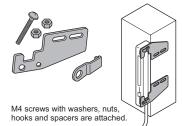
-NA1-1



and hooks are attached.









## SPECIFICATIONS

$\langle$	Ту	NPN output	PNP output		
tem	Model N	o. NA1-11	NA1-11-PN		
Sensir	ng height	100 mm	a 3.937 in		
Sensir	ng range (Note 2)	0.17 to 1 m 0.	0.17 to 1 m 0.558 to 3.281 ft		
leme	ent pitch	10 mm 0.394 in			
umb Ieme	per of emitting / receivir ents	g 11 Nos. each on the emitter	11 Nos. each on the emitter and the receiver, respectively		
Sensir	ng object	ø13.5 mm ø0.531 in or more opaque object (Note 3)			
Suppl	y voltage	12 to 24 V DC ±10 %	12 to 24 V DC ±10 % Ripple P-P 10 % or less		
Currer	nt consumption	Emitter: 80 mA or less, Receiver: 100 mA or less			
Output		NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less (between output and 0 V) • Residual voltage: 1 V or less (at 100 mA sink current) 0.4 V or less (at 16 mA sink current)	<ul> <li>PNP open-collector transistor</li> <li>Maximum source current: 100 mA</li> <li>Applied voltage: 30 V DC or less (between output and +V)</li> <li>Residual voltage: 1 V or less (at 100 mA source current)</li> <li>0.4 V or less (at 16 mA source current)</li> </ul>		
l	Utilization category	DC-12 0	pr DC-13		
(	Output operation	ON or OFF when beam channel is interru	pted, selectable by operation mode switch		
5	Short-circuit protection	Incorp	porated		
Respo	onse time	In Dark state: 5 ms or less, In Light state: 10 ms or less			
	<b>F</b> :#	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the large indicator input is Low,	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the large indicator input is High,		
	Emitter	lighting pattern is selected by operation mode switch	lighting pattern is selected by operation mode switch		
	Receiver	Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the \	Operation indicator: Orange LED (lights up when the output is ON Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the		
	Receiver	large indicator input is Low, lighting pattern is selected by operation mode switch	large indicator input is Hig lighting pattern is selected by operation mode switch		
F	Pollution degree	3 (Industrial environment)			
F	Protection	IP62 (IEC)			
e /	Ambient temperature	-10 to 55 °C +14 to +131 °F (No dew condensation or icing allowed), Storage: -20 to +70 °C -4 to +158 °F			
SISTA	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH			
Ambient temperature Ambient humidity Ambient illuminance EMC Voltage withstandability Insulation resistance		Incandescent light: 3,000 &	Incandescent light: 3,000 ℓx at the light-receiving face		
nent	EMC	EN 60947-5-2			
Voltage withstandability		1,000 V AC for one min. between all supply	terminals connected together and enclosure		
Env L	Insulation resistance	20 M $\Omega$ , or more, with 250 V DC megger between al	20 MΩ, or more, with 250 V DC megger between all supply terminals connected together and enclosure		
N	Vibration resistance	10 to 150 Hz frequency, 1.5 mm 0.059 in amplitude in X, Y and Z directions for two hours each			
Shock resistance		500 m/s <sup>2</sup> acceleration (50 G approx.) in X, Y and Z directions for three times each			
mitti	ng element	Infrared LED (Peak emission wavelength: 880nm 0.035mil, cross-beam scanning system)			
Material		Enclosure: Heat-resistant ABS, Lens: Acrylic, Indicator cover: Acrylic			
Cable		0.3 mm <sup>2</sup> 4-core (emitter: 3-core) oil resistant cabtyre cable, 2 m 6.562 ft long			
Cable	extension	Extension up to total 100 m 328.084 ft is possible, for both emitter and receiver, with 0.3 mm <sup>2</sup> , or more, cable.			
Weigh	nt	Net weight: Emitter 80 g approx., Receiver	r 85 g approx, Gross Weight: 210 g approx.		
	1) M/bara magaurama	t conditions have not been specified precisely, the conditions used			

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +23 °C +73.4 °F. 2) The sensing range is the possible setting distance between the emitter and the receiver. The sensor can detect an object less than 0.17 m 0.558 ft away.

Receiver cannot be placed in this range 0.17 m 0.558 ft Setting range of the receiver

3) Although this product can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. When this sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.

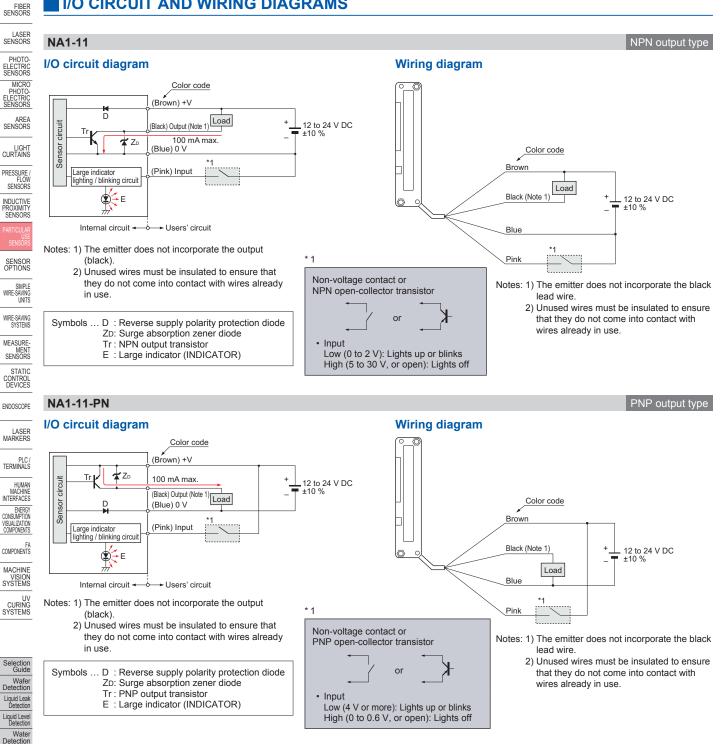
FIBER SENSORS

> nall / Slim pject Detectio

Obstacle Detection

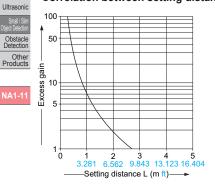
Other Products

# I/O CIRCUIT AND WIRING DIAGRAMS



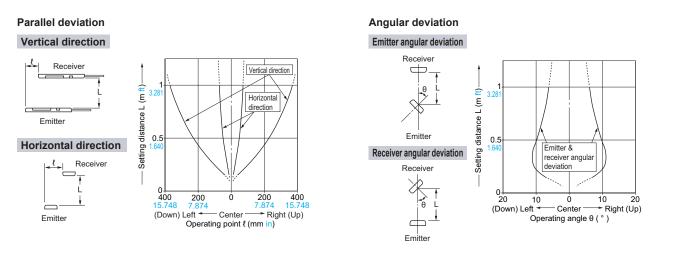
# SENSING CHARACTERISTICS (TYPICAL)

Correlation between setting distance and excess gain

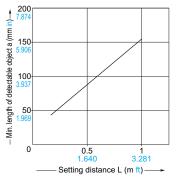


Color Mark Detection Hot Melt Glue Detection

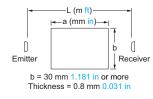
# SENSING CHARACTERISTICS (TYPICAL)



#### Correlation between setting distance and minimum length of detectable object



The minimum length of the detectable object, which lies in a plane perpendicular to the sensor front surface, varies with the setting distance, as shown in the left graph. However, note that the minimum length of the detectable object also varies with the object thickness.



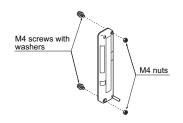
\* The sensing object is considered to be placed at the center of the sensing area.

# PRECAUTIONS FOR PROPER USE

- Never use this product as a sensing device for personnel protection.
- For sensing devices to be used as safety devices for press machines or for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.
- If this product is used as a sensing device for personnel protection, death or serious body injury could result.
- For a product which meets safety standards, use the following products. Type 4: **SF4B** series
- Type 2: SF2B series

#### Mounting

 Use M4 screws with washers and M4 nuts. The tightening torque should be 0.5 N·m or less. (Purchase the screws and nuts separately.)



#### Selection of large indicator operation

• Lighting / Blinking is selected by the operation mode switch on the emitter and the receiver.

Operation of	Operation mode switch		
large indicator	Emitter	Receiver	
Lighting	LIGHT 🔳 BLINK	LIGHT BLINK	
Blinking			

#### Selection of output operation

- The output operation mode is selected by the operation mode switch on the receiver.
  - (The switches must be set with the power supply off. The operation mode does not change if the switch setting is changed with the power supplied.

Operation mode switch (Receiver)		Output operation	Operation indicator (Orange)
D-ON	D/ON L/ON	ON in Dark state	Lights up when the output is ON
L-ON		OFF in Dark state	Lights up when the output is ON

Note: LIGHT / BLINK switch is not related to the output operation selection.

FIBER SENSORS

LASER SENSORS

PHOTO-ELECTRIC SENSORS

MICRO PHOTO-ELECTRIC SENSORS

AREA SENSORS

LIGHT CURTAINS

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Selection Guide

Wafer Detection

Liquid Leak Detection

Liquid Level

Water Detection

Color Mark Detection

Hot Melt Glue Detection

Ultrasonic

Small / Slim Obiect Detect

Obstacle Detection

Other Products

Refer to General precautions.

PLC / TERMINALS

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Liquid Leak

Liquid Level Detection Water Detection

Color Mark Detection

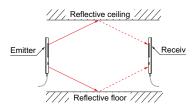
Hot Melt Glue

Detection Ultrasonic Small / Sim Object Detection Obstacle Detection Other Products

## **PRECAUTIONS FOR PROPER USE**

#### Others

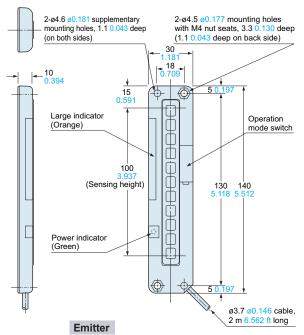
- Do not use during the initial transient time (0.5 sec.) after the power supply is switched on.
- Although this sensor can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. Hence, when the sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.
- In case of this sensor, light from the emitter spreads above and below the sensor. Hence, take care that if there is a reflective object above or below the sensor it will affect the sensing.



\* Refer to "Parallel deviation" in "SENSING CHARACTERISTICS (TYPICAL)".

#### DIMENSIONS (Unit: mm in)

# NA1-11 NA1-11-PN



**18** 10 0.394 →| 5 15 0.59  $\odot$ ¢  $\Box$ Operation Large indicator Φ mode switch (Orange) 100 (Sensing height) Power indicator 140 130 5 (Green) Operation indicator (Orange)  $\odot$ Ţ ø3.7 ø0.146 cable, 2 m 6.562 ft long Receiver

0 deep

30

2-ø4.5 ø0.177 mounting holes

(1.1 0.043 deep on back side)

with M4 nut seats. 3.3 0

The CAD data in the dimensions can be downloaded from our website.

2-ø4.6 ø0.181 supplementary

mounting holes, 1.1 0.043 deep (on both sides)

Refer to General precautions.

NA1-11

#### DIMENSIONS (Unit: mm in)

The CAD data in the dimensions can be downloaded from our website.

